MOSFETs Silicon N-Channel MOS (U-MOSVII)

# **TPC8081**

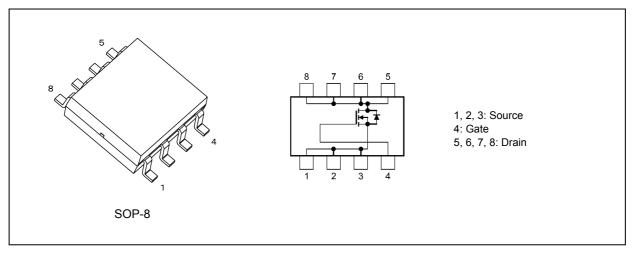
#### 1. Applications

- Notebook PCs
- Mobile Equipment

#### 2. Features

- (1) Small footprint due to a small and thin package
- (2) Low drain-source on-resistance:  $R_{DS(ON)} = 2.5 \text{ m}\Omega$  (typ.) (V<sub>GS</sub> = 10 V)
- (3) Low leakage current:  $I_{DSS}$  = 10  $\mu$ A (max) ( $V_{DS}$  = 30 V)
- (4) Enhancement mode:  $V_{th}$  = 1.3 to 2.3 V (V\_{DS} = 10 V,  $I_{D}$  = 0.5 mA)

#### 3. Packaging and Internal Circuit



#### 4. Absolute Maximum Ratings (Note) ( $T_a = 25 \ ^{\circ}C$ unless otherwise specified)

Characteristics			Symbol	Rating	Unit
Drain-source voltage			V <sub>DSS</sub>	30	V
Gate-source voltage			V <sub>GSS</sub>	±20	1
Drain current (DC)		(Note 1)	Ι <sub>D</sub>	18	A
Drain current (pulsed)		(Note 1)	I <sub>DP</sub>	72	1
Power dissipation	(t = 10 s)	(Note 2)	PD	1.9	W
Power dissipation	(t = 10 s)	(Note 3)	PD	1.0	W
Single-pulse avalanche energy		(Note 4)	E <sub>AS</sub>	421	mJ
Avalanche current			I <sub>AR</sub>	18	A
Channel temperature			T <sub>ch</sub>	150	°C
Storage temperature			T <sub>stg</sub>	-55 to 150	7

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 5. Thermal Characteristics

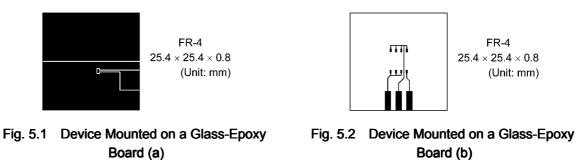
Characteristics				Max	Unit
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	R <sub>th(ch-a)</sub>	65.7	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R <sub>th(ch-a)</sub>	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V<sub>DD</sub> = 24 V, T<sub>ch</sub> = 25 °C (initial), L = 1.0 mH, R<sub>G</sub> = 1  $\Omega$ , I<sub>AR</sub> = 18 A



Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

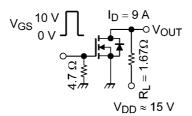
#### 6. Electrical Characteristics

### 6.1. Static Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V			±0.1	μA
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			10	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	30	_	_	V
	V <sub>(BR)DSX</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = -20 V	15		_	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.5 mA	1.3		2.3	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 9 A		3.2	4.0	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 9 A		2.5	3.2	

### 6.2. Dynamic Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	—	3600	_	pF
Reverse transfer capacitance	C <sub>rss</sub>		—	200	_	
Output capacitance	C <sub>oss</sub>	]		680	_	
Switching time (rise time)	tr	See Fig. 6.2.1.	—	3.4	_	ns
Switching time (turn-on time)	t <sub>on</sub>		—	13	_	]
Switching time (fall time)	t <sub>f</sub>	]	_	6.7	_	
Switching time (turn-off time)	t <sub>off</sub>	]	_	47	_	



Duty 
$$\leq$$
 1%, t<sub>w</sub> = 10  $\mu$ s

Fig. 6.2.1 Switching Time Test Circuit

#### 6.3. Gate Charge Characteristics ( $T_a = 25$ °C unless otherwise specified)

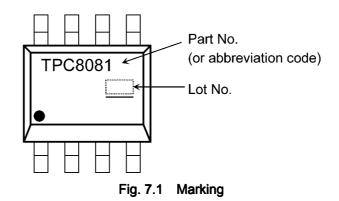
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 24$ V, $V_{GS}$ = 10 V, $I_D$ = 18 A	_	51	—	nC
Gate-source charge 1	Q <sub>gs1</sub>		_	11	—	
Gate-drain charge	Q <sub>gd</sub>		_	6.4	_	

#### 6.4. Source-Drain Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note	5) I <sub>DRP</sub>	—	_	_	72	А
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 18 A, V <sub>GS</sub> = 0 V			-1.2	V

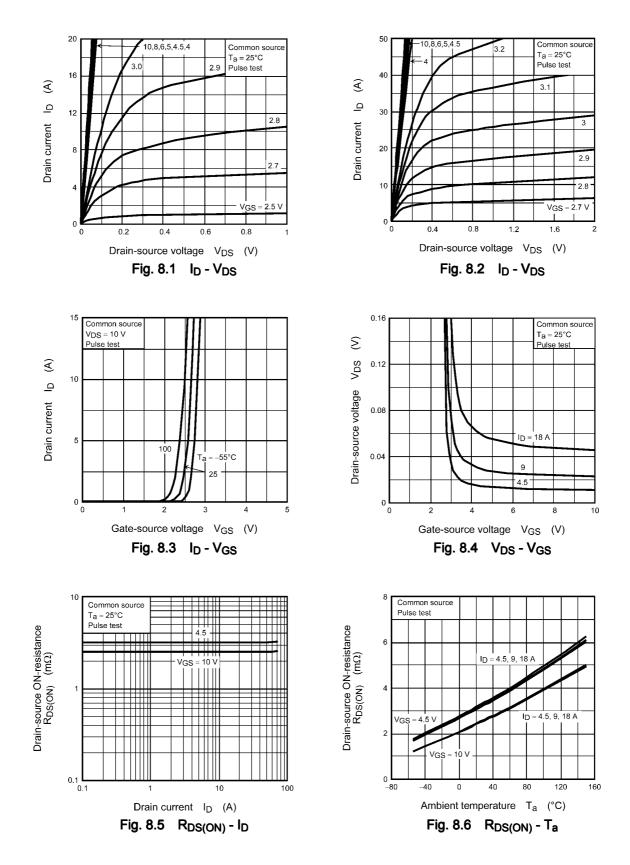
Note 5: Ensure that the channel temperature does not exceed 150 °C.

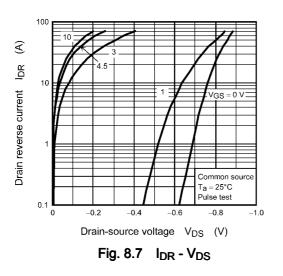
### 7. Marking (Note)

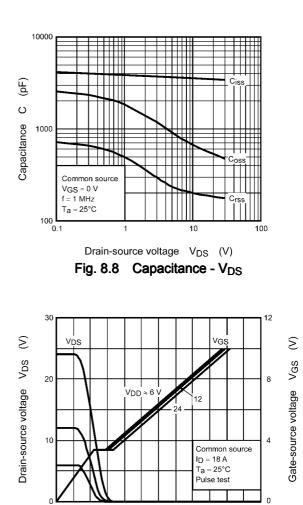


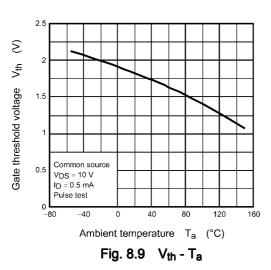
 Note: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

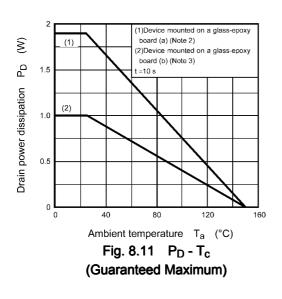
### 8. Characteristics Curves (Note)











Total gate charge Q<sub>g</sub> (nC) Fig. 8.10 Dynamic Input/Output Characteristics

30

40

50

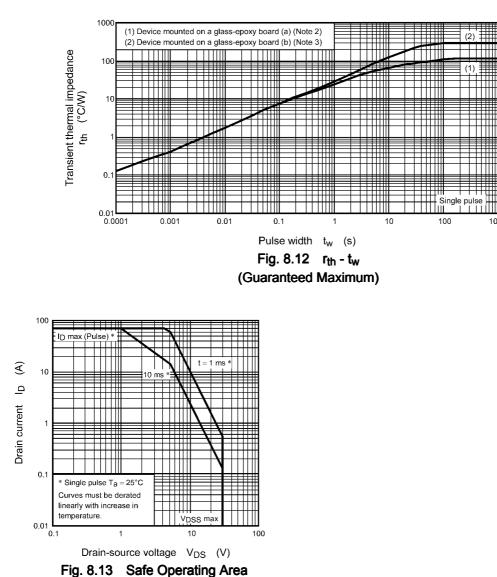
60

10

0

20

1000



(Guaranteed Maximum)

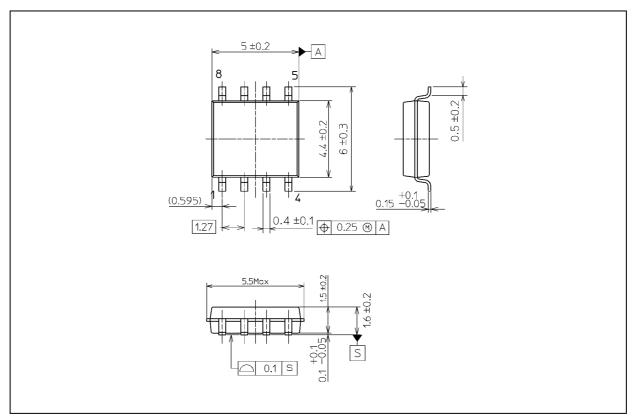
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Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### TPC8081

#### Package Dimensions

Unit: mm



#### Weight: 0.085 g (typ.)

Package Name(s)	
TOSHIBA: 2-6J1S	
Nickname: SOP-8	

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